

## 5 W Low-Cost Packaged PHEMT GaAs Power FETs

### FEATURES

- 5 W Typical Output Power at 6 GHz
- 7 dB Typical Linear Power Gain at 6 GHz
- High Linearity: IP3 = 47 dBm Typical at 6 GHz
- High Power Added Efficiency:  
Nominal PAE of 40 % at 6 GHz
- Suitable for High Reliability Application
- Breakdown Voltage:  $BV_{DGO} \geq 18$  V
- $L_g = 0.6 \mu\text{m}$ ,  $W_g = 12$  mm
- Tight  $V_p$  ranges control
- High RF input power handling capability
- 100 % DC Tested
- Low Cost Ceramic Package

### PHOTO ENLARGEMENT



### DESCRIPTION

The TC2876 is packaged with the TC1806 Pseudomorphic High Electron Mobility Transistor (PHEMT) GaAs Power chip. The Cu-based ceramic package provides excellent thermal conductivity for the GaAs FET. All devices are 100% DC tested to assure consistent quality. Typical applications include high dynamic range power amplifiers for commercial and military high performance power applications.

### ELECTRICAL SPECIFICATIONS ( $T_A = 25^\circ\text{C}$ )

Symbol	CONDITIONS	MIN	TYP	MAX	UNIT
$P_{1dB}$	Output Power at 1dB Gain Compression Point, $f = 6$ GHz $V_{DS} = 8$ V, $I_{DS} = 1200$ mA	36	36.5		dBm
$G_L$	Linear Power Gain, $f = 6$ GHz $V_{DS} = 8$ V, $I_{DS} = 1200$ mA		7		dB
IP3	Intercept Point of the 3 <sup>rd</sup> -order Intermodulation, $f = 6$ GHz $V_{DS} = 8$ V, $I_{DS} = 1200$ mA, $*P_{SCL} = 23$ dBm		47		dBm
PAE	Power Added Efficiency at 1dB Compression Power, $f = 6$ GHz		40		%
$I_{DSS}$	Saturated Drain-Source Current at $V_{DS} = 2$ V, $V_{GS} = 0$ V		3		A
$g_m$	Transconductance at $V_{DS} = 2$ V, $V_{GS} = 0$ V		2000		mS
$V_p$	Pinch-off Voltage at $V_{DS} = 2$ V, $I_D = 24$ mA		-1.7**		Volts
$BV_{DGO}$	Drain-Gate Breakdown Voltage at $I_{DGO} = 6$ mA	18	22		Volts
$R_{th}$	Thermal Resistance		3.5		$^\circ\text{C/W}$

**Note: \*  $P_{SCL}$ : Output Power of Single Carrier Level.**

\*\* For the tight control of the pinch-off voltage range, we divide TC2876 into 3 model numbers to fit customer design requirement

(1)TC2876P1519 :  $V_p = -1.5\text{V to } -1.9\text{V}$  (2)TC2876P1620 :  $V_p = -1.6\text{V to } -2.0\text{V}$  (3)TC2876P1721 :  $V_p = -1.7\text{V to } -2.1\text{V}$

If required, customer can specify the requirement in purchasing document. For special  $V_p$  requirement, please contact factory for details.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25 °C)**

Symbol	Parameter	Rating
V <sub>DS</sub>	Drain-Source Voltage	12 V
V <sub>GS</sub>	Gate-Source Voltage	-5 V
I <sub>DS</sub>	Drain Current	I <sub>DSS</sub>
P <sub>in</sub>	RF Input Power, CW	33 dBm
P <sub>T</sub>	Continuous Dissipation	12 W
T <sub>CH</sub>	Channel Temperature	175 °C
T <sub>STG</sub>	Storage Temperature	- 65 °C to +175 °C

**RECOMMENDED OPERATING CONDITION**

Symbol	Parameter	Rating
V <sub>DS</sub>	Drain to Source Voltage	8 V
I <sub>D</sub>	Drain Current	1200 mA

**HANDLING PRECAUTIONS:**

The user must operate in a clean, dry environment. Electrostatic Discharge (ESD) precautions should be observed at all stages of storage, handling, assembly, and testing. The static discharge must be less than 300V.

**OUTLINE DIMENSIONS (Unit: inch)**
